

# Octal Transparent Latch, 3-State

CD54/74AC/ACT563 - Inverting CD54/74AC/ACT573 - Non-Inverting

### Type Features:

- Buffered inputs
- Typical propagation delay: 4.3 ns @ V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25° C, C<sub>L</sub> = 50 pF

The RCA-CD54/74AC563 and CD54/74AC573 and the CD54/74ACT563 and CD54/74ACT573 octal transparent 3-state latches use the RCA ADVANCED CMOS technology. The outputs are transparent to the inputs when the Latch Enable (LE) is HIGH. When the Latch Enable (LE) goes LOW, the data is latched. The Output Enable (OE) controls the 3-state outputs. When the Output Enable (OE) is HIGH, the outputs are in the high-impedance state. The latch operation is independent of the state of the Output Enable.

The CD74AC/ACT563 and CD74AC/ACT573 are supplied in 20-lead dual-in-line plastic packages (E suffix) and in 20-lead dual-in-line small-outline plastic packages (M suffix). Both package types are operable over the following temperature ranges: Commercial (0 to 70°C); Industrial (-40 to +85°C); and Extended Industrial/Military (-55 to +125°C).

The CD54AC/ACT563 and CD54AC/ACT573, available in chip form (H suffix), are operable over the -55 to +125°C temperature range.

# Family Features:

- Exceeds 2-kV ESD Protection MIL-STD-883, Method 3015
- SCR-Latchup-resistant CMOS process and circuit design
- Speed of bipolar FAST\*/AS/S with significantly reduced power consumption
- Balanced propagation delays
- AC types feature 1.5-V to 5.5-V operation and balanced noise immunity at 30% of the supply
- ± 24-mA output drive current
  - Fanout to 15 FAST\* ICs
  - Drives 50-ohm transmission lines

### TRUTH TABLE

| Output<br>Enable | Latch<br>Enable | Data | AC/ACT563<br>Output | AC/ACT573<br>Output |
|------------------|-----------------|------|---------------------|---------------------|
| L.               | н               | н    | L                   | н                   |
| L                | н               | L    | Н                   | L                   |
| L                | L               | 1    | н ।                 | L                   |
| L                | L               | h    | L                   | Н                   |
| н                | X               | ×    | Z                   | Z                   |

### Note

- L = Low voltage level
- H = High voltage level
- 1 = Low voltage level one set-up time prior to the high to low latch enable transition
- h ≈ High voltage level one set-up time prior to the high to low latch enable transition.
- X = Don't Care
- Z ≈ High Impedance State

This data sheet is applicable to the CD74AC563, CD54/74AC573, and CD54/74ACT573. The CD54AC563 and CD54/74ACT563 were not acquired from Harris Semiconductor.

<sup>\*</sup>FAST is a Registered Trademark of Fairchild Semiconductor Corp.

RECOMMENDED OPERATING CONDITIONS:

For maximum reliability, normal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC   | LIW  | LINUTO         |              |
|--|--|----------------|--------------|
|  | 1.5 5.5 4.5 5.5 0 V <sub>cc</sub> -55 +125 | UNITS          |              |
| Supply-Voltage Range, V <sub>Cc</sub> *:<br>(For T <sub>A</sub> = Full Package-Temperature Range)<br>AC Types<br>ACT Types       | i -  |                | V            |
| DC Input or Output Voltage, V <sub>I</sub> , V <sub>O</sub>  | 0  | Vcc            | V            |
| Operating Temperature, T <sub>A</sub> :  | -55  | +125           | °C           |
| Input Rise and Fall Slew Rate, dt/dv<br>at 1.5 V to 3 V(AC Types)<br>at 3.6 V to 5.5 V(AC Types)<br>at 4.5 V to 5.5 V(ACT Types) | 0 0  | 50<br>20<br>10 | ns/V<br>ns/V |

<sup>\*</sup>Unless otherwise specified, all voltages are referenced to ground.

### **TERMINAL ASSIGNMENT DIAGRAMS**



CD54/74AC563, CD54/74ACT563

CD54/74AC573, CD54/74ACT573

STATIC ELECTRICAL CHARACTERISTICS: AC Series

|                                  |                 |                              |                        |                 |      | AMBIEN | TEMPE  | RATURE | (T <sub>A</sub> ) - °( | С        | Ţ <u></u> |
|----------------------------------|-----------------|------------------------------|------------------------|-----------------|------|--------|--------|--------|------------------------|----------|-----------|
| CHARACTERISTICS                  | S               | TEST COM                     | IDITIONS               | V <sub>cc</sub> | +:   | 25     | -40 to | o +85  | -55 to                 | +125     | UNITS     |
|                                  |                 | V,<br>(V)                    | l <sub>o</sub><br>(mA) | (V)             | MIN. | MAX.   | MIN.   | MAX.   | MIN.                   | MAX.     |           |
| High-Level Input                 |                 |                              |                        | 1.5             | 1.2  | _      | 1.2    | _      | 1.2                    |          |           |
| Voltage                          | V <sub>IH</sub> |                              |                        | 3               | 2.1  | _      | 2.1    |        | 2.1                    |          | V         |
|                                  |                 |                              |                        | 5.5             | 3.85 |        | 3.85   | _      | 3.85                   |          | ]         |
| Low-Level Input                  |                 |                              |                        | 1.5             | _    | 0.3    | _      | 0.3    |                        | 0.3      |           |
| • Voltage                        | VIL             |                              |                        | 3               |      | 0.9    | _      | 0.9    | '                      | 0.9      | V         |
|                                  |                 |                              |                        | 5.5             | _    | 1.65   | _      | 1.65   | <u> </u>               | 1.65     |           |
| High-Level Output                |                 |                              | -0.05                  | 1.5             | 1.4  |        | 1.4    |        | 1.4                    | _        |           |
| Voltage                          | V <sub>OH</sub> | ViH                          | -0.05                  | 3               | 2.9  | _      | 2.9    | _      | 2.9                    | _        |           |
|                                  |                 | or                           | -0.05                  | 4.5             | 4.4  |        | 4.4    | _      | 4.4                    |          | 1         |
|                                  |                 | VıL                          | -4                     | 3               | 2.58 | _      | 2.48   | _      | 2.4                    | _        | V         |
|                                  |                 |                              | -24                    | 4.5             | 3.94 |        | 3.8    |        | 3.7                    | _        | 1         |
|                                  |                 | (                            | -75                    | 5.5             | _    |        | 3.85   | _      | _                      | <u> </u> | 1         |
|                                  | #. * {          | -50                          | 5.5                    |                 | _    | _      | _      | 3.85   | _                      | 1        |           |
| Low-Level Output                 |                 |                              | 0.05                   | 1.5             | _    | 0.1    |        | 0.1    |                        | 0.1      |           |
| Voltage                          | $V_{\text{OL}}$ | ViH                          | 0.05                   | 3               | _    | 0.1    |        | 0.1    |                        | 0.1      | 1         |
|                                  |                 | or                           | 0.05                   | 4.5             | _    | 0.1    | _      | 0.1    | _                      | 0.1      | 1         |
|                                  |                 | VıL                          | 12                     | 3               | _    | 0.36   | _      | 0.44   | _                      | 0.5      | V         |
|                                  |                 | ·                            | 24                     | 4.5             | _    | 0.36   |        | 0.44   | _                      | 0.5      | 1         |
| •                                |                 | (                            | 75                     | 5.5             |      |        |        | 1.65   | _                      | _        | 1         |
|                                  |                 | #, * {                       | 50                     | 5.5             | _    | _      |        | _      |                        | 1.65     | 1         |
| Input Leakage<br>Current         | 1,              | V <sub>cc</sub><br>or<br>GND |                        | 5.5             | _    | ±0.1   | _      | ±1     | _                      | ±1       | μΑ        |
| 3-State Leakage                  |                 | ViH                          |                        |                 |      |        |        |        |                        |          |           |
| Current                          | loz             | or                           |                        |                 |      |        |        |        |                        |          |           |
|                                  |                 | Vic                          |                        |                 |      |        |        |        |                        |          | ļ         |
|                                  |                 | Vo=                          |                        | 5.5             | _    | ±0.5   | _      | ±5     | _                      | ±10      | μΑ        |
|                                  |                 | Vcc                          |                        |                 |      |        |        |        |                        |          |           |
|                                  |                 | or                           |                        |                 |      |        |        | 1      |                        |          |           |
|                                  |                 | GND                          |                        |                 |      |        |        |        |                        |          |           |
| Quiescent Supply<br>Current, MSI | Icc             | V <sub>cc</sub><br>or<br>GND | 0                      | 5.5             |      | 8      |        | 80     |                        | 160      | μΑ        |

<sup>#</sup>Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

\* Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

# STATIC ELECTRICAL CHARACTERISTICS: ACT Series

|   |   |  |                         |                  |             | AMBIEN    | T TEMP        | ERATURE | E (T <sub>A</sub> ) - ° | С    |              |
|---|---|--|-------------------------|------------------|-------------|-----------|---------------|---------|-------------------------|------|--------------|
| CHARACTERIST  | ice.  | TEST CO  | NDITIONS                | V <sub>cc</sub>  | +           | 25        | -40 1         | o +85   | -55 to +125             |      |              |
| or introduction   |   |  | I <sub>o</sub> (V) (mA) |                  | MIN.        | MIN. MAX. |               | MAX.    | MIN.                    | MAX. | UNITS        |
| High-Level Input<br>Voltage   | V <sub>IH</sub>                                 |  |                         | 4.5<br>to<br>5.5 | 2           | _         | 2             | _       | 2                       | -    | v            |
| Low-Level Input<br>Voltage  | Vil   |  |                         | 4.5<br>to<br>5.5 |             | 0.8       | _             | 0.8     | _                       | 0.8  | v            |
| High-Level Output   |   | V <sub>IH</sub>  | -0.05                   | 4.5              | 4.4         |           | 4.4           | _       | 4.4                     | _    |              |
| Voltage Vol   | Voltage V <sub>OH</sub> or V <sub>IL</sub> #, * |  | -24                     | 4.5              | 3.94        |           | 3.8           | _       | 3.7                     | -    | V.           |
|   |   | 1 6  | -75                     | 5.5              | _           |           | 3.85          | _       |                         | _    | ] <b>v</b> . |
|   |   |  | -50                     | 5.5              |             |           |               |         | 3.85                    |      |              |
| Low-Level Output<br>Voltage   |   | V <sub>IH</sub>  | 0.05                    | 4.5              |             | 0.1       | _             | 0.1     | _                       | 0.1  |              |
| voltage vol   | ViL   | 24   | 4.5                     | _                | 0.36        | l —       | 0.44          | _       | 0.5                     | ]    |              |
|   |   | #, * {   | 75                      | 5.5              |             |           | _             | 1.65    | _                       | _    | \ \          |
|   |   | <u>"'</u>  | 50                      | 5.5              |             | _         | _             | _       | _                       | 1.65 | 1            |
| Input Leakage<br>Current  | l <sub>t</sub>                                  | V∞<br>or<br>GND  |                         | 5.5              | _           | ±0.1      | _             | ±1      | _                       | ±1   | μΑ           |
| 3-State Leakage<br>Current  | loz   | V <sub>IH</sub><br>or                                  |                         |                  |             |           |               |         |                         |      |              |
|   |   | V <sub>IL</sub><br>V <sub>O</sub> =<br>V <sub>CC</sub> |                         | 5.5              | <del></del> | ±0.5      | _             | ±5      | -                       | ±10  | μΑ           |
|   |   | or<br>GND  |                         |                  |             |           |               |         |                         |      |              |
| Quiescent Supply<br>Current, MSI  | Icc   | V <sub>cc</sub><br>or<br>GND                           | 0                       | 5.5              |             | 8         | <del></del> . | 80      | _                       | 160  | μΑ           |
| Additional Quiescent<br>Current per Input P<br>TTL Inputs High<br>1 Unit Load | Supply<br>in<br>ΔI <sub>cc</sub>                | V <sub>cc</sub> -2.1                                   |                         | 4.5<br>to<br>5.5 | _           | 2.4       | _             | 2.8     |                         | 3    | , mA         |

<sup>#</sup>Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

\*Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

# **ACT INPUT LOADING TABLE**

| INPUT | UNIT LOAD* |        |  |  |  |  |
|-------|------------|--------|--|--|--|--|
|       | ACT563     | ACT573 |  |  |  |  |
| ŌĒ    | 0.87       | 0.87   |  |  |  |  |
| Dn    | 0.5        | 0.5    |  |  |  |  |
| LĒ    | 0.8        | 0.8    |  |  |  |  |

\*Unit load is  $\Delta I_{CC}$  limit specified in Static Characteristics Chart, e.g., 2.4 mA max. @ 25°C.

# PREREQUISITE FOR SWITCHING: AC Series

|                          |        | [                      |                  | AMBIENT TEMPERATURE (TA) -°C |                |       |       |  |
|--------------------------|--------|------------------------|------------------|------------------------------|----------------|-------|-------|--|
| CHARACTERISTICS          | SYMBOL | V <sub>cc</sub><br>(V) | -40 to +85       |                              | -55 to +125    |       | UNITS |  |
|                          |        |                        | MIN.             | MAX.                         | MIN.           | MAX.  |       |  |
| LE Pulse                 |        | 1.5                    | 44               | _                            | 50             | _     |       |  |
| Width                    | tw     | 3.3*<br>5†             | 4.9<br>3.5       |                              | 5.6<br>4       | _     | ns    |  |
| Setup Time<br>Data to LE | tsu    | 1.5<br>3.3<br>5        | 2<br>2<br>2      |                              | 2<br>2<br>2    | _<br> | ns    |  |
| Hold Time<br>Data to LE  | tн     | 1.5<br>3.3<br>5        | 33<br>3.7<br>2.6 |                              | 38<br>4.2<br>3 |       | ns    |  |

\*3.3 V: min. is @ 3 V †5 V: min. is @ 4.5 V

# SWITCHING CHARACTERISTICS: AC Series; t, t, = 3 ns, C, = 50 pF

|   |                                      |                        | AMBII         | AMBIENT TEMPERATURE (TA) - °C |               |                     |       |  |
|---|--------------------------------------|------------------------|---------------|-------------------------------|---------------|---------------------|-------|--|
| CHARACTERISTICS   | SYMBOL                               | V <sub>cc</sub><br>(V) | -40 t         | o +85                         | -55 to        | +125                | UNITS |  |
|   |                                      | (*)                    | MIN.          | MAX.                          | MIN.          | MAX.                | 1     |  |
| Propagation Delays:<br>Data to Qn<br>AC563  | t <sub>PLH</sub><br>t <sub>PHL</sub> | 1.5<br>3.3*<br>5†      | 3.8<br>2.7    | 119<br>13.4<br>9.5            | 3.7<br>2.6    | 131<br>14.7<br>10.5 | ns    |  |
| AC573   | tегн<br>teнr                         | 1.5<br>3.3<br>5        | 3.1<br>2.2    | 96<br>10.8<br>7.7             | -<br>3<br>2.1 | 106<br>11.9<br>8.5  | ns    |  |
| LE on Qn<br>AC563   | t <sub>PLH</sub><br>t <sub>PHL</sub> | 1.5<br>3.3<br>5        | 4.3<br>3.1    | 136<br>15.3<br>10.9           | -<br>4.2<br>3 | 150<br>16.8<br>12   | ns    |  |
| AC573   | tpLH<br>tpHL                         | 1.5<br>3.3<br>5        | 4.3<br>3.1    | 136<br>15.3<br>10.9           | 4.2<br>3      | 150<br>16.8<br>12   | ns    |  |
| Output Enable Times   | tezi<br>tezh                         | 1.5<br>3.3<br>5        | 4.1<br>2.7    | 119<br>14.4<br>9.5            | -<br>4<br>2.6 | 131<br>15.8<br>10.5 | ns    |  |
| Output Disable Times  | t <sub>PLZ</sub><br>t <sub>PHZ</sub> | 1.5<br>3.3<br>5        | 3.7<br>3      | 131<br>13.1<br>10.5           | 3.6<br>2.9    | 144<br>14.4<br>11.5 | ns    |  |
| Power Dissipation Capacitance   | C <sub>PO</sub> §                    | _                      | 63            | Тур.                          | 63            | Тур.                | рF    |  |
| Min. (Valley) V <sub>OH</sub> During Switching of Other Outputs (Output Under Test Not Switching) | V <sub>онv</sub><br>See<br>Fig. 1    | 5                      |               | ٧                             |               |                     |       |  |
| Max. (Peak) V <sub>OL</sub> During Switching of Other Outputs (Output Under Test Not Switching)   | V <sub>OLP</sub><br>See<br>Fig. 1    | 5                      | 1 Typ. @ 25°C |                               |               |                     | V     |  |
| Input Capacitance   | Cı                                   |                        |               | 10                            |               | 10                  | pF    |  |
| 3-State Output Capacitance  | Co                                   | _                      | <u> </u>      | 15                            |               | 15                  | pF    |  |

\*3.3 V: min. is @ 3.6 V max. is @ 3 V

†5 V: min. is @ 5.5 V max. is @ 4.5 V

§C<sub>PO</sub> is used to determine the dynamic power consumption, per latch.

 $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$  where  $f_i = input$  frequency

C<sub>L</sub> = output load capacitance

 $V_{CC}$  = supply voltage.

# PREREQUISITE FOR SWITCHING: ACT Series

|                          |                 | V <sub>cc</sub><br>(V) | AMBI       |      |             |      |       |
|--------------------------|-----------------|------------------------|------------|------|-------------|------|-------|
| CHARACTERISTICS          | SYMBOL          |                        | -40 to +85 |      | -55 to +125 |      | UNITS |
|                          |                 |                        | MIN.       | MAX. | MIN.        | MAX. |       |
| LE Pulse<br>Width        | tw              | 5†                     | 3.5        | _    | 4           | _    | ns    |
| Setup Time<br>Data to LE | t <sub>su</sub> | 5                      | 2          | _    | 2           | _    | ns    |
| Hold Time<br>Data to LE  | tн              | 5                      | 2.6        | _    | 3           | _    | ns    |

†5 V: min. is @ 4.5 V

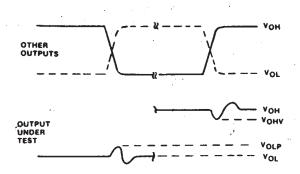
# SWITCHING CHARACTERISTICS: ACT Series; t,, t, = 3 ns, C, = 50 pF

|   |                                      |                        | AMBI                          |           |             |  |       |
|---|--------------------------------------|------------------------|-------------------------------|-----------|-------------|--|-------|
| CHARACTERISTICS   | SYMBOL                               | V <sub>cc</sub><br>(V) | -40 to +85                    |           | -55 to +125 |  | UNITS |
|   |                                      |                        | MIN.                          | MAX.      | MIN.        | MAX.   | 1     |
| Propagation Delays:<br>Data to Qn<br>563  | t <sub>PLH</sub>                     |                        | 2.9                           | 10.4      | 2.9         | 11.4   |       |
| 573   | 1                                    | 5†                     | 2.7                           | 9.4       | 2.6         | 10.4   | ns    |
| LE to Qn<br>563<br>573  | t <sub>PLH</sub><br>t <sub>PHL</sub> | 5                      | 3.2                           | 11.4      | 3.1         | 12.5   | ns    |
| Output Enable Times   | t <sub>PZL</sub><br>t <sub>PZH</sub> | 5                      | 3.5                           | 12.3      | 3.4         | 13.5   | ns    |
| Output Disable Times  | t <sub>PLZ</sub>                     | 5                      | 3.2                           | 11.4      | 3.1         | 12.5   | ns    |
| Power Dissipation Capacitance   | CPO§                                 | <del></del>            | 63                            | L<br>Гур. | 63          | <u>I                                    </u> | pF    |
| Min. (Valley) V <sub>он</sub> During Switching of Other Outputs (Output Under Test Not Switching) | V <sub>онv</sub><br>See<br>Fig. 1    | 5                      | 63 Typ. 63 Typ. 4 Typ. @ 25°C |           |             |  | ٧     |
| Max. (Peak) Vol. During Switching of Other Outputs (Output Under Test Not Switching)              | V <sub>OLP</sub><br>See<br>Fig. 1    | 5                      | 1 Тур. @ 25°С                 |           |             | V  |       |
| Input Capacitance   | C <sub>i</sub>                       |                        |                               | 10        | _           | 10   | ρF    |
| 3-State Output Capacitance  | Co                                   | _                      | _                             | 15        |             | 15   | pF    |

†5 V: min. is @ 5.5 V max. is @ 4.5 V

§CPD is used to determine the dynamic power consumption, per latch.  $P_D = V_{cc}^2 f_c (C_{PD} + C_L) + V_{cc} \Delta I_{cc}$  where  $f_c = input$  frequency  $C_L = output$  load capacitance  $V_{cc} = supply voltage$ .

# PARAMETER MEASUREMENT INFORMATION

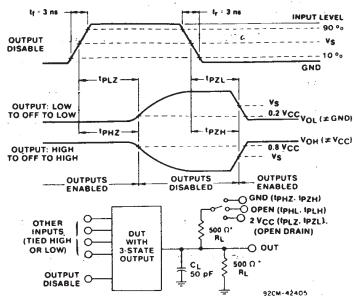


### NOTES:

- 1. V<sub>OHV</sub> AND V<sub>OLP</sub> ARE MEASURED WITH RESPECT TO A GROUND REFERENCE NEAR THE OUTPUT UNDER TEST.
- 2. INPUT PULSES HAVE THE FOLLOWING CHARACTERISTICS:

9205-42406

Fig. 1 - Simultaneous switching transient waveforms.



\*FOR AC SERIES ONLY: WHEN  $V_{CC} = 1.5~V_{\rm t} R_L = 1~k\Omega$ 

Fig. 2 - Three-state propagation delay waveforms and test circuit.

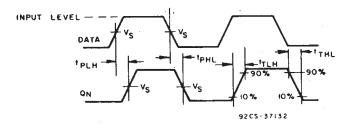


Fig. 3 - Data to Qn output propagation delays.

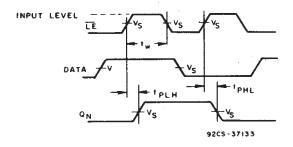


Fig. 4 - Latch enable propagation delays.

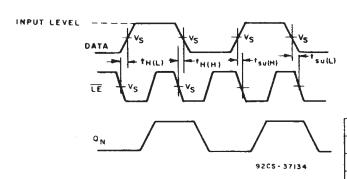


Fig. 5 - Latch enable prerequisite times.

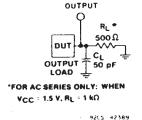


Fig. 6 - Test circuit.

|                              | CD54/74AC           | CD54/74ACT          |
|------------------------------|---------------------|---------------------|
| Input Level                  | V <sub>cc</sub>     | 3 V                 |
| Input Switching Voltage, Vs  | 0.5 V <sub>cc</sub> | 1.5 V               |
| Output Switching Voltage, Vs | 0.5 V <sub>cc</sub> | 0.5 V <sub>CC</sub> |







# **PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup>  | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|-----------------|--------------------|------|----------------|----------------------------|------------------|------------------------------|
| CD54AC573F3A     | ACTIVE                | CDIP            | J                  | 20   | 1              | TBD                        | A42 SNPB         | N / A for Pkg Type           |
| CD54ACT573F3A    | ACTIVE                | CDIP            | J                  | 20   | 1              | TBD                        | A42 SNPB         | N / A for Pkg Type           |
| CD74AC563E       | ACTIVE                | PDIP            | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74AC563EE4     | ACTIVE                | PDIP            | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74AC573E       | ACTIVE                | PDIP            | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74AC573EE4     | ACTIVE                | PDIP            | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74AC573M       | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC573M96     | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC573M96E4   | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC573M96G4   | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC573ME4     | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74AC573MG4     | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT573E      | ACTIVE                | PDIP            | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74ACT573EE4    | ACTIVE                | PDIP            | N                  | 20   | 20             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD74ACT573M      | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT573M96    | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT573M96E4  | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT573M96G4  | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT573ME4    | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD74ACT573MG4    | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>&</sup>lt;sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <a href="http://www.ti.com/productcontent">http://www.ti.com/productcontent</a> for the latest availability information and additional product content details.



# PACKAGE OPTION ADDENDUM

9-Oct-2007

for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



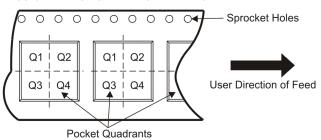
# TAPE AND REEL INFORMATION



# TAPE DIMENSIONS + K0 - P1 - B0 W Cavity - A0 -

|    | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



# \*All dimensions are nominal

| Device        | Package<br>Type | Package<br>Drawing |    |      | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|---------------|-----------------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| CD74AC573M96  | SOIC            | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8    | 13.0    | 2.7     | 12.0       | 24.0      | Q1               |
| CD74ACT573M96 | SOIC            | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8    | 13.0    | 2.7     | 12.0       | 24.0      | Q1               |





\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD74AC573M96  | SOIC         | DW              | 20   | 2000 | 346.0       | 346.0      | 41.0        |
| CD74ACT573M96 | SOIC         | DW              | 20   | 2000 | 346.0       | 346.0      | 41.0        |

# 14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# DW (R-PDSO-G20)

# PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.



# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

### **Products Amplifiers** amplifier.ti.com Data Converters dataconverter.ti.com DSP dsp.ti.com Clocks and Timers www.ti.com/clocks Interface interface.ti.com Logic logic.ti.com Power Mgmt power.ti.com Microcontrollers microcontroller.ti.com www.ti-rfid.com RF/IF and ZigBee® Solutions www.ti.com/lprf

| Applications       |                           |
|--------------------|---------------------------|
| Audio              | www.ti.com/audio          |
| Automotive         | www.ti.com/automotive     |
| Broadband          | www.ti.com/broadband      |
| Digital Control    | www.ti.com/digitalcontrol |
| Medical            | www.ti.com/medical        |
| Military           | www.ti.com/military       |
| Optical Networking | www.ti.com/opticalnetwork |
| Security           | www.ti.com/security       |
| Telephony          | www.ti.com/telephony      |
| Video & Imaging    | www.ti.com/video          |
| Wireless           | www.ti.com/wireless       |

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2008, Texas Instruments Incorporated